TOSHIBA PHOTOCOUPLER GaAIAs IRED & PHOTO-TRIAC

# TLP3064(S)

: 600V(Min)

: 3mA(Max)

: 100mA(Max)

:SS EN60065 SS EN60950, File No.9841102

No.8385

: 5000Vrms(Min)

:BS EN60065, File

:DIN VDE0884 Approved No.83649

:890V<sub>PK</sub>

:8000 VPK

:UL1577,File No.E67349

BS EN60950, File No.8386

#### OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

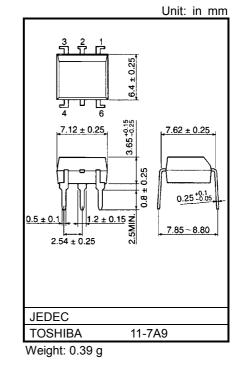
The TOSHIBA TLP3064(S) consists of a zero voltage crossing turn-on photo-triac optically coupled to a GaAlAs infrared emitting diode in a six lead plastic DIP package.

- Peak Off-State Voltage
- Trigger LED Current
- On-State Current
- Isolation Voltage
- UL Recognized
- SEMKO Approved
- BSI Approved
- Option(D4)type
  VDE Approved
- Maximum Operating Insulation Voltage
- Highest Permissible Over Voltage

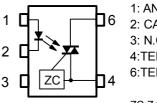
# (Note)When a VDE0884 approved type is needed, please designate the "Option(D4)"

Construction Mechanical Rating

	7.62 mm pich standard type	10.16 mm pich TLPXXXF type
Creepage Distance	7.0 mm (Min)	8.0 mm (Min)
Clearance	7.0 mm (Min)	8.0 mm (Min)
Insulation Thickness	0.5 mm (Min)	0.5 mm (Min)



#### **PIN CONFIGURATION (TOP VIEW)**



- 1: ANODE 2: CATHODE 3: N.C. 4:TERMINAL1
- 6:TERMINAL

ZC:Zero-cross Circuit

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#### MAXIMUM RATINGS(Ta=25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT		
	Forward Current	١ <sub>F</sub>	30	mA		
Q	Forward Current Derating (Ta≥25°C)	∆l <sub>F</sub> /°C	-0.3	mA /°C		
LED	Peak Forward Current (100µs pulse, 100pps)		I <sub>FP</sub>	1	А	
	Reverse Voltage		V <sub>R</sub>	5	V	
	Junction Temperature	Tj	125	°C		
	Off-State Output Terminal Voltage			600	V	
	On-State RMS Current	Ta=25°C	I <sub>T(RMS)</sub>	100	mA	
0R		Ta=70°C	I (RMS)	50		
DETECTOR	On-State Current Derating (Ta≥25°C)	∆I <sub>T</sub> /°C	-1.1	mA /°C		
DE	Peak On-State Current (100µs pulse, 120pps)	I <sub>TP</sub>	2	А		
	Peak Nonrepetitive Surge Current (Pw=10ms,DC=10	I <sub>TSM</sub>	1.2	А		
	Junction Temperature	Tj	115	°C		
Ope	erating Temperature Range	T <sub>opr</sub>	-40~100	°C		
Stor	rage Temperature Range	T <sub>stg</sub>	-55~150	°C		
Lea	d Soldering Temperature (10s)	T <sub>sol</sub>	260	°C		
Isola	ation Voltage (AC,1min. , R.H.≤60%)	BVS	5000	Vrms		

(Note 2)Device considered a two terminal device:Pins1,2 and 3 shorted together and pin4 and pin6 shorted together.

#### **RECOMMENDED OPERATING CONDITIONS**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V <sub>AC</sub>	—	—	240	V <sub>ac</sub>
Forward Current	I <sub>F</sub>	4.5	6	7.5	mA
Peak On-State Current	I <sub>TP</sub>	_	_	1	А
Operating Temperature	T <sub>opr</sub>	-10	_	85	°C

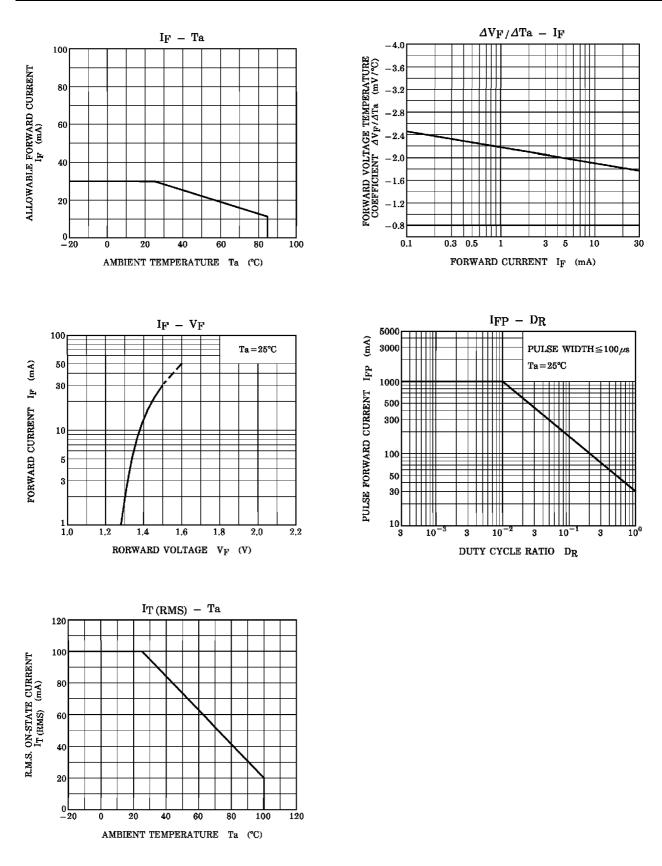
#### INDIVIDUAL ELECTRICAL CHARACTERISTICS(Ta=25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	VF	I <sub>F</sub> = 10 mA	1.2	1.4	1.7	V
LED	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 3 V		_	10	μA
	Capacitance	Ст	V = 0, f=1MHz	_	30	—	pF
	Peak Off-State Current	I <sub>DRM</sub>	V <sub>DRM</sub> =600V	—	10	1000	nA
OR	Peak On-State Voltage	V <sub>TM</sub>	I <sub>TM</sub> =100mA		_	3.0	V
C L	Holding Current	Iн	—		0.6	_	mA
DETE	Critical Rate of Rise of Off-State Voltage	dv/dt	Vin=240Vrms, Ta=85°C (Note3)	200	500	_	V/µs
	Critical Rate of Rise of Commutating Voltage	dv/dt(c)	Vin=60Vrms, IT=15mA (Note3)	_	0.2	_	V/µs

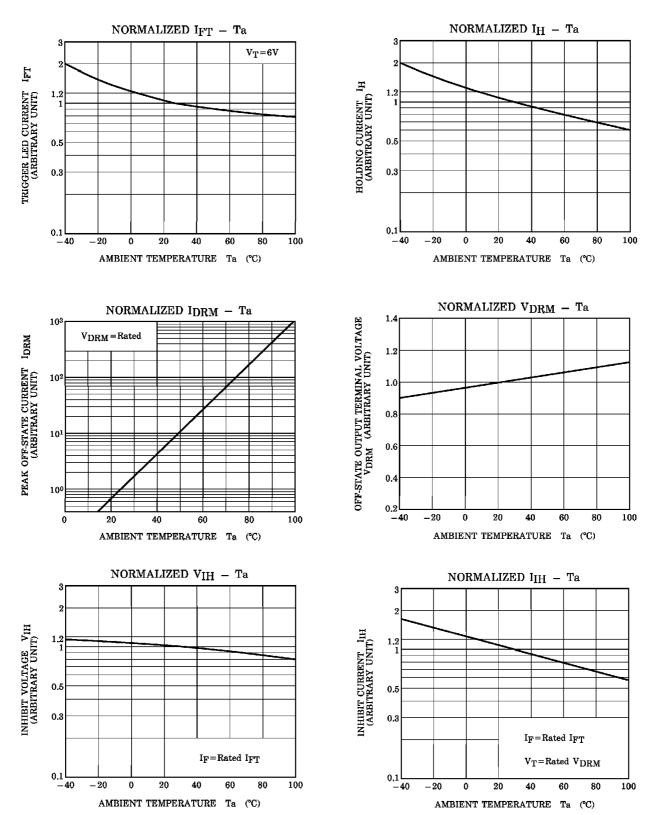
#### COUPLED ELECTRICAL CHARACTERISTICS(Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I <sub>FT</sub>	V⊤=6V ,Resistive Load	—	_	3	mA
Inhibit Voltage	VIH	IF=Rated I <sub>FT</sub>	—	—	50	V
Leakage in Inhibited State	I <sub>IH</sub>	IF=Rated I <sub>FT</sub> , V <sub>T</sub> =Rated V <sub>DRM</sub>	—	—	600	μA
Capacitance (Input to Output)	Cs	VS=0 , f=1MHz	—	0.8	_	pF
Isolation Resistance	Rs	VS=500V ,R.H.≤60%	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
		AC , 1minute	5000	_	_	Vrms
Isolation Voltage	$BV_S$	AC , 1second,in oil	—	10000	—	VIIIS
		DC, 1minute,in oil	_	10000	_	Vdc

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